ELECTRONIC PROPERTIES OF III-V SEMICONDUCTOR INTERFACES

Final Report: November 1980
ONR Contract N00014-76-C-0976
Contract Authority NR 243-015

by

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Report SF 29

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Final contract year dealt with dc transport in InP and GaAs device structures at low temperatures and high magnetic fields. Primary emphasis was on the mobility profile in field effect transistors, with secondary emphasis on basic bulk transport mechanisms. In previous years, studies were made of GaAs MIS structures, encapsulation of GaAs for annealing, and electronic profiling of InAs layers.
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1. **INTRODUCTION**

The four year duration of ONR Contract NO0014-76-C-0976 was divided into two somewhat distinct phases. The first three years' work was all performed at Colorado State University. It dealt with (1) metal-insulator-semiconductor (MIS) structures on GaAs, (2) encapsulation of GaAs with oxides and nitrides of silicon and aluminum for annealing purposes, and (3) electronic profiling of thin InAs layers. This work was summarized in the 1979 annual report (Report SF 25, available on request), and will not be repeated except for the list of publications and reports (Sec. 8).

During the final year of this Contract, Prof. Sites worked at the Naval Ocean Systems Center (NOSC) in San Diego; the results and conclusions of that year will be reported in some detail in the following sections. The goal was to expand our knowledge of transport processes in actual device structures. The theme of the measurements performed was dc conductivity and Hall coefficient in high magnetic fields and at low temperatures. Systems studied included (1) indium phosphide field effect transistor structures with silicon devices for reference, (2) gallium arsenide depletion mode Schottky barrier transistors (MESFET), (3) gallium arsenide depletion and enhancement mode junction field effect transistors (JFET), and (4) gallium arsenide epitaxial layers cooled to the impurity band regime.

Much of the transport work was performed in collaboration with Harry Wieder of NOSC. Considerable assistance and advice was also received from the other members of the NOSC staff, particularly Fred Nedoluha, Dave Collins, Larry Neinors, Derek Lile, and Carl Zeisse. And several of the samples studied were supplied by industrial colleagues including Rainer Zuleeg of McDonnell-Douglas, Joe Diesel of Hewlett-Packard, Tom Mills and Ron Kaelberer of TRW, and Ralph Williams of Texas Instruments.
2. **INDIUM PHOSPHIDE STRUCTURES**

Supplementary to the NOSC program for the development of high speed indium phosphide devices, measurements were made of the InP channel transport as a function of gate voltage, temperature, and magnetic field. Most of the structures studied were n-channel pseudo-inversion mode FET's as shown in Fig. 1b. The structure is conceptually similar to the standard inversion mode FET (Fig. 1a) in that a conductive channel is formed by inducing a large curvature in the energy bands near the semiconductor surface. In contrast to the standard structure with a p-type substrate, the pseudo-inversion mode device forms the conductive channel in a semi-insulating substrate. Potential advantages are the lack of capacitive coupling to the substrate and a somewhat lower turn-on voltage.

Magnetoresistance was utilized as a tool to deduce the channel carrier mobility, and a comparison was made to field effect mobilities measured under the same conditions. The magnetoresistance technique is particularly powerful because it does not require assumptions about surface states and because the typical FET geometry is a good approximation to the Corbino disk analysis where \( \Delta \rho / \rho = \mu^2 B^2 \) for \( B \ll 1 \). Field effect mobility, which works well for silicon, suffers in systems with large numbers of surface states because one cannot directly separate gate induced free carriers from induced trapped surface charge. Thus, changes in the channel carrier density may not be simply given by the capacitor charging relation \( \Delta N = \Delta V_C C / qA \).

The specific InP devices measured had a 1000 Å plasma deposited SiO₂ gate insulator and a gate length of 4 μm. Contacts were made by epitaxial growth of heavily doped n-type InP. Curve tracer displays of the transistor characteristics were qualitatively similar to standard silicon transistors.
Fig. 1. Device structures studied.
They were, however, not flat in the saturation region, and the transconductance dropped off somewhat (\textasciitilde 25\%) as dc conditions were approached. The latter is interpreted as an indication that slow trapping processes were present.

The magnetoresistance and field effect mobilities, as a function of gate voltage, are shown in Fig. 2 for several different temperatures. Source-drain voltages were generally 50 or 100 mV where the channel current is approximately linear in voltage. Both magnetoresistance and field effect mobilities are average channel mobilities and not incremental mobilities. Instability in the value of the turn-on voltage made determination of its temperature dependence difficult. It was, however, generally in the 0-1 volt range. The general trend in Fig. 2 is for the mobility of a low density channel to increase with gate voltage and then level off close to 1000 cm$^2$/V-sec. Gate leakage precluded study of higher channel densities than those shown. There seems, however, to be a gradual fall-off in both mobilities for densities of $10^{12}$ and above. The two mobilities agree well in magnitude at lower temperatures. Closer to room temperature, the field effect mobility appears to be artificially low, perhaps due to the surface state effect mentioned above. Hall measurements by Larry Meiners on a similar sample show rough agreement with the data of Fig. 2.

A search was made for quantum oscillations in the magneto-conductance of the InP pseudo-inversion layer. An n-channel silicon MOSFET used for reference showed very pronounced oscillations when the gate voltage was varied in a constant magnetic field of 4 tesla or greater. The period of the oscillations was inverse to the magnetic field and the temperature dependence consistent with an effective mass of 0.20 to 0.25. The InP device under the same conditions, however, did not show the quantum oscillations.
Fig. 2. Mobility of pseudo-inversion mode InP devices.
oscillations. Presumably the explanation is that the somewhat lower mobility (\(\sim 1000 \text{ cm}^2/\text{V-sec}\)) would require a magnetic field of 10 tesla, just beyond the range of the magnet used. Higher field measurements at Grenoble (K. v. Klitzing, Th. Englert, and D. Fritzsche, J. Appl. Phys., to be published) have subsequently demonstrated the existence of quantum oscillations in similar InP devices.

A second type of InP structure, the depletion mode MIS transistor, was also studied. The active part of this device was an ion implanted n-layer (see Fig. 1c). Mobility of the channel deduced from magnetoresistance is shown in Fig. 3 using circles. Also shown for reference, particularly to show the approach to pinch-off, is the channel conductance. The channel mobility is lower than that characteristic of bulk material. Furthermore (Fig. 4a), it has only a weak temperature dependence, with the broad maximum occurring just below room temperature. These pieces of information suggest a large amount of impurity scattering.

In addition, the magnetoresistance mobility decreases as pinch-off is approached (Fig. 3), in much the same manner as the GaAs devices described in Sec. 4. Note also that the mobility and conductance approximately track with temperature (Fig. 4b), implying the free carrier density is relatively constant down to 4 K. Finally (Fig. 4c), a pinch-off voltage is observed that decreases with lowered temperature. It is not known whether this shift is due to effects within the oxide or at the semiconductor interface.

3. **GALLIUM ARSENIDE MESFET'S**

A comparative study was made of channel mobilities in GaAs Schottley barrier depletion mode transistors (Fig. 1d) acquired from a variety of
Fig. 3. Mobility and conductance of depletion mode InP transistor. Top 290 K, middle 130 K, bottom 4 K.
Fig. 4. Temperature dependence of mobility, conductance, and pinch-off voltage for depletion mode InP device.
sources. Details of this study are contained in Report SF 27 which will be published in the December 1980 issue of the IEEE Proceedings on Electron Devices. The MESFET active layers were made by liquid phase epitaxy (LPE), vapor phase epitaxy (VPE), and ion implantation. All devices had an electron concentration the order of $10^{17}$ and a gate length between 0.6 and 2 $\mu$m.

Again the magnetoresistance technique was used to deduce the average channel mobility and its dependence on gate voltage. Source drain voltages were kept at 50 to 100 mV as before. The mobilities for five devices are shown in Fig. 5 with the corresponding values of channel carrier density. The room temperature values were all the order of 4000 cm$^2$/V-sec and were relatively constant with gate voltage except in the pinch-off region. Near pinch-off, they decreased by 30-60%. The drop in mobility may be due to electron scattering from interfacial defects or to enhanced compensation from chromium diffusion into epilayer. The decrease appears to be somewhat less pronounced in the VPE devices made with buffer layers than in the LPE devices grown directly on the substrate.

The temperature dependence of the MESFET mobilities was fairly weak with the exception of one device (VPE-I) with an apparent composition grading so that part of the channel was in the $10^{16}$ cm$^{-3}$ range. This part of the channel increased in mobility from 4800 cm$^2$/V-sec at room temperature to 10,000 cm$^2$/V-sec near 100 K. The pinch-off voltage of the GaAs MESFET's was very steady with temperature (<0.2 volt change) in contrast with the InP device in the previous section.

The effect of magnetic field on transistors operated in the saturation region was also examined. (Report SF 30; to be submitted to IEEE Electron
Fig. 5. Mobility and channel electron density for five GaAs MESFET's.
Device Letters.) In general, the short channel devices showed a clear onset of electron transfer as exhibited by a downward kink (See Fig. 6) in the transistor curves at a source-drain voltage corresponding to an electric field near $10^4$ V/cm. As the magnetic field was increased, the kink became less pronounced (Fig. 6a) and moved to slightly higher voltages (Fig. 6c). It disappeared altogether at fields above 2 tesla. Presumably, the explanation is that when the effective electron mobility in the central valley is sufficiently reduced (in this case to about 2000 cm$^2$/V-sec) that the transition to a secondary valley is both more difficult to achieve and has less impact on the transistor operation when it does occur.

4. **GALLIUM ARSENIDE JFET'S**

Another type of device studied was the GaAs junction field effect transistor (JFET). These devices, shown in Fig. 1e, were made by a double ion implantation technique at McDonnell-Douglas. Conceptually, they are very similar to the MESFET, and some effort was made to compare the two types of structure.

One group of the JFET's studied were fabricated in the standard depletion mode configuration where the p-type gate was implanted into the top part of a thicker n-channel. These devices were normally ON and required a negative gate voltage to turn off. Other devices were implanted in such a way that the n-channel remaining after the p-implant was very thin and fully depleted under zero bias. These enhancement mode devices are normally OFF and require a forward bias across the junction for current flow in the channel. The operating range between channel turn-on and significant forward current through the diode is inherently fairly small.
Fig. 6. Influence of magnetic field on transferred electron effect.
Mobilities were once again deduced from magnetoresistance measurements. The depletion mode results were quite similar to the MESFET results in Fig. 5. The mobility magnitude was approximately 4000 cm$^2$/V-sec, increasing slightly at reduced temperatures and decreasing near pinch-off. A set of results from one of the enhancement mode devices is shown in Fig. 7. Maximum mobility in this case is closer to 3000 cm$^2$/sec, probably because the thinner channel is inherently close to a pinch-off condition. This reduction may be a reasonable price to pay for a normally OFF transistor. Also shown in Fig. 7 is the shift in built-in potential with temperature, and the corresponding change in turn-on voltage of approximately -1 mV/K.

The quality and stability of the JFET diode, particularly under forward bias conditions, was investigated. The earlier studies with MESFET's showed a tendency for the built-in voltage to shift to higher values ($\Delta V \sim 50$ to $150$ mV) when a forward bias is applied to the gate. In some cases the gate suffered irreversible breakdown with relatively little forward current. The ion implanted JFET's did not exhibit either of these effects. Furthermore, down to about 100 K they showed very nearly exponential current-voltage curves with a temperature independent quality factor equal to 2.0.

5. SHORT CHANNEL DEVICES

Another class of ion implanted devices supplied by McDonnell-Douglas was the short channel (0.5 µm) GaAs structure shown in Fig. 1f. These gateless channels were designed to be used as current limiters in integrated JFET circuitry. Such structures are known to have a non-ohmic current-voltage relationship at low temperatures, and the $3/2$ power law observed...
Fig. 7. Mobility of enhanced mode GaAs JFET.
was taken to be suggestive of a ballistic transport process (R. Zuleeg, IEEE Electron Device Lett., EDL-1, 234, 1980).

More exhaustive current-voltage measurements were made with several devices and representative results are shown in Fig. 8. It can be seen that below 200 K the conductance is constant until a critical field (500-5000 V/cm) is reached, and then the current increases more rapidly than voltage. At still higher voltages, current limitation becomes effective and the current approaches a constant value. Magnetoresistance measurements suggest that the channel mobility is too low for ballistic transport from source to drain.

The tentative explanation for Fig. 8 is an increased electron temperature effect. The increase in conductance only occurs at temperatures below the mobility maximum, and the conductance appears to approach the higher temperature values as the effect becomes more pronounced. Furthermore, the increased conductance sets in at electric field values that correspond to an electron drift velocity. Therefore, it is quite possible that the higher velocity electrons in an electric field are simply scattered less than they would be with smaller velocities in zero field.

6. IMPURITY BAND TRANSPORT

Details of electronic transport in bulk GaAs and InP in high magnetic fields and low temperatures have been investigated. At temperatures the order of 30 K and below, a significant fraction of the donor impurities are no longer ionized and transport via the conduction band becomes progressively more difficult. If the impurity concentration is sufficiently large, however, that neighboring wave functions overlap, transport is still
Fig. 8. Current and conductance of short channel GaAs current limiter.
possible. Measurements of dc conductivity and Hall coefficient in this regime have been made, the results analyzed, and a report prepared for publication. (Report SF 28, submitted to Physical Review.)

Historically, impurity band conduction has been studied by comparing samples with different doping concentrations, by varying the carrier concentration in an inversion layer, or, as in the present case, by varying the wavefunction overlap with a magnetic field. We (Dr. A. K. Nedoluha and myself) have interpreted the transport data of bulk samples by assuming there are three conduction possibilities: the conduction band, the upper Hubbard band and the lower Hubbard band. We further assume that the conductivities and the quantity $B_{ij}$, the off-diagonal term in the conductivity tensor, are additive and are of the form $A_j \exp(-E_j/kT)$. In fact, the best fit values for $A_j$ and $E_j$ for the three bands yield good agreement with the experimental data. In a magnetic field, the coefficients vary systematically and experimental agreement remains good.

Fig. 9 shows the measured Hall coefficient of a $1.5 \times 10^{16}$ cm$^{-3}$ GaAs epilayer function of temperature for several magnetic fields. The pronounced peak occurs at the transition from conduction band transport and that in the upper Hubbard band. The size of the peak should be roughly one-fourth the mobility ratio of the two bands. At high magnetic fields, the wavefunction overlap between neighboring impurities decreases, the effective mobility of the impurity band decreases, and the peak grows, shifting to slightly lower temperature. A second transition between the two Hubbard bands ($\approx 2$ K) is much less obvious in the data shown here.

Fig. 10 shows the variation of conductivity with magnetic field as one progressively cools through the same impurity band transition. At high temperatures the transverse magnetoresistance is essentially $(\mu B)^2$ corrected
Fig. 9. GaAs Hall coefficient showing impurity band transition.
Fig. 10. Magnetic field dependence of GaAs conductivity.
for geometry and the longitudinal magnetoresistance is for practical purposes zero. At lower temperatures, in the impurity band transport regime, the magnetoresistance becomes exponential in the first power of magnetic field, and the distinction between transverse and longitudinal values disappears. There is an onset value for magnetic field effects of two tesla, which roughly corresponds to the field necessary to distort the classical Bohr orbit.

7. COMMENTS ON FINAL YEAR

Overall perspective has been gained on transport processes in compound semiconductors, for the most part using actual device structures. The capabilities of some less common characterization techniques have been explored. The ability to do these measurements in parallel with state-of-the-art development programs, in fact using the same samples, has been particularly rewarding. To me, this past year illustrates the many advantages of cooperation between universities, industry, and government labs. I would encourage increased facilitation of similar opportunities for other scientists.

8. REPORTS AND PUBLICATIONS

The technical reports listed below were generated during the four years Contract NO0014-76-C-0976 was in effect. They are available on request. Additionally, the 1979 Annual Report ($F 25) gives a comprehensive summary of the first three years of the Contract.


SF 23: "Depth and Carrier Concentration Dependence of Photoluminescence Features in Heat Treated GaAs:Si," by Hülya Birey and James Sites, unpublished.


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